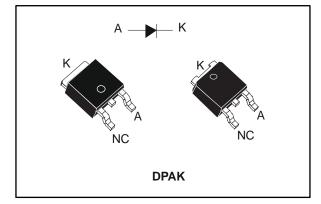


STPS8L30

Low drop power Schottky rectifier

Datasheet - production data



Features

- Low cost device with low drop forward voltage for less power dissipation and reduced heatsink
- Optimized conduction/reverse losses trade-off which leads to the highest yield in the application
- High power surface mount miniature
 package
- Avalanche capability specified
- ECOPACK[®]2 compliant component for DPAK on demand

Description

Single Schottky rectifier suited to switched mode power supplies and high frequency DC to DC converters.

Packaged in DPAK, this device is especially intended for use as a rectifier at the secondary of 3.3 V SMPS or DC/DC units, freewheeling and polarity protection applications.

Table 1: Device summary

Symbol	Value
lf(AV)	8 A
V _{RRM}	30 V
T _j (max.)	150 °C
V _F (typ.)	0.35 V

October 2016

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This is information on a product in full production.

1 Characteristics

Table 2: Absolute ratings (limiting values at 25 °C, unless otherwise specified)

Symbol	Parameter	Value	Unit	
Vrrm	Repetitive peak reverse voltage		30	V
I _{F(RMS)}	Forward rms current		7	А
I _{F(AV)}	Average forward current δ = 0.5, square waveT_c = 135 °C		8	А
I _{FSM}	Surge non repetitive forward current t _p = 10 ms sinusoidal		75	А
PARM	Repetitive peak avalanche power $t_p = 10 \ \mu s, T_j = 125 \ ^{\circ}C$		215	W
T _{stg}	Storage temperature range		-65 to +150	°C
Tj	Maximum operating junction temperature ⁽¹⁾		150	°C

Notes:

 $^{(1)}(dP_{tot}/dT_j) < (1/R_{th(j\text{-}a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 3:	Thermal	parameters
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Symbol	Parameter	Max. value	Unit
Rth(j-c)	Junction to case	2.5	°C/W

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C		-		1	mA
IR	Reverse leakage current	T _j = 100 °C	$V_R = V_{RRM}$	-	15	40	
	V _F ⁽¹⁾ Forward voltage drop	T _j = 25 °C	I _F = 8 A	-		0.49	
λ_{I}		T _j = 125 °C		-	0.35	0.40	V
VF		T _j = 25 °C	l⊧ = 16 A	-		0.63	v
		T _j = 125 °C	IF = 10 A	-	0.448	0.57	

Table 4: Static electrical characteristics

Notes:

 $^{(1)}\text{Pulse test:}$ tp = 380 µs, δ < 2%

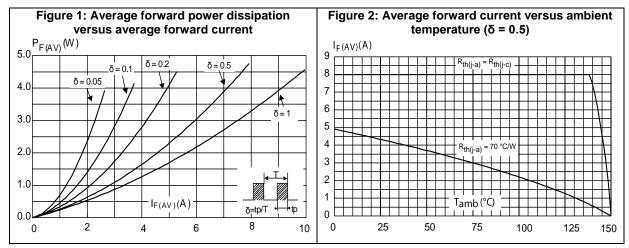
To evaluate the conduction losses, use the following equation:

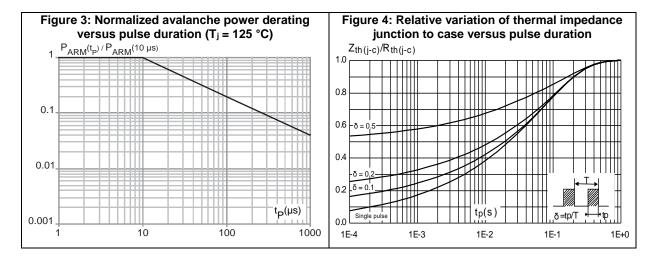
 $P = 0.23 \text{ x } I_{F(AV)} + 0.021 \text{ x } I_{F}^{2}(\text{RMS})$

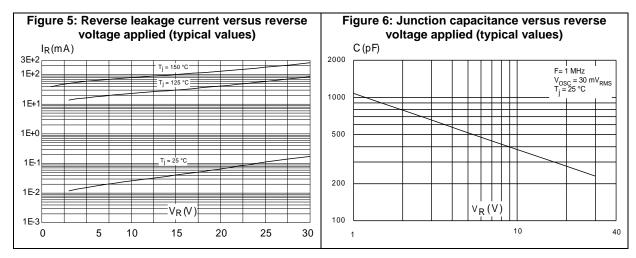


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1.1 Characteristics (curves)



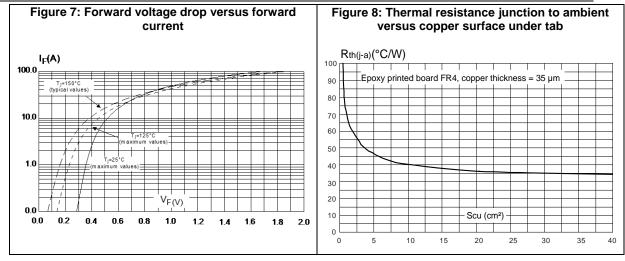




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Characteristics

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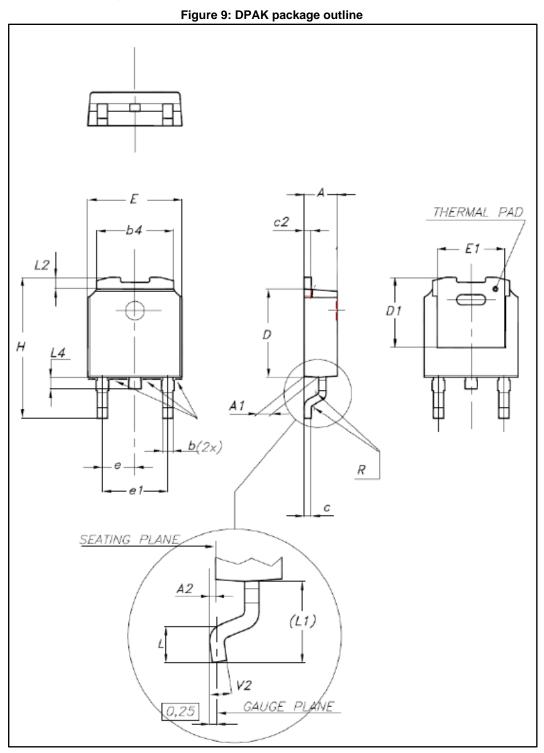
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0



2.1 DPAK package information





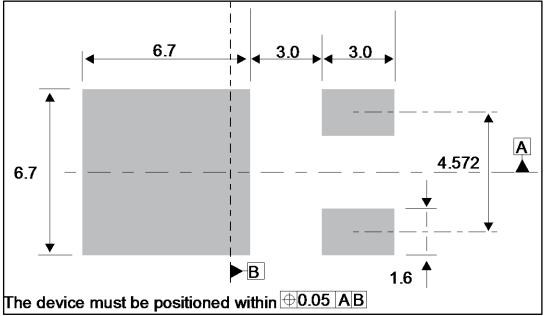
This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.



Package information

Table 5: DPAK package mechanical data						
	Dimensions					
Ref.	Milli	Millimeters		Inches		
	Min.	Max.	Min.	Max.		
А	2.18	2.40	0.085	0.094		
A1	0.90	1.10	0.035	0.043		
A2	0.03	0.23	0.001	0.009		
b	0.64	0.90	0.025	0.035		
b4	4.95	5.46	0.194	0.215		
с	0.46	0.61	0.018	0.024		
c2	0.46	0.60	0.018	0.023		
D	5.97	6.22	0.235	0.244		
D1	4.95	5.60	0.194	0.220		
E	6.35	6.73	0.250	0.265		
E1	4.32	5.50	0.170	0.216		
е	2.2	86 typ.	0.09	0 typ.		
e1	4.40	4.70	0.173	0.185		
Н	9.35	10.40	0.368	0.409		
L	1.0	1.78	0.039	0.070		
L2		1.27		0.050		
L4	0.60	1.02	0.023	0.040		
V2	-8°	+8°	-8°	+8°		

Figure 10: DPAK recommended footprint (dimensions in mm)



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3 Ordering information

	т	able 6: Orderii	ng informatio	on	
Order code	Marking	Package	Weight	Base qty.	Delivery mode
STPS8L30B-TR	LS 30	DPAK	0.32 g	2500	Tape and reel

4 Revision history

Table 7: Document revision history	Table 7:	Document	revision	history
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Date	Revision	Changes
Jul-2002	2A	First issue
16-Apr-2005	3	IPAK package Added.
01-Mar-2006	4	IPAK connector identifiers corrected on page 1. ECOPACK statement added. Document reformatted to current standard.
18-Oct-2016	5	Updated DPAK package information and reformatted to current standard. Removed IPAK package.



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